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(54) Title: ELECTROCONDUCTIVE RESIN COMPOSITION AND MOLDED PRODUCT THEREOF

(57) Abstract: An electroconductive resin composition, comprising at least: a multi-component polymer-type resin binder (A) comprising a dispersed phase and a continuous phase, and having a number-average particle size of dispersed phase of 0.001-2 µm, and an electroconductive material (B) in the form of powder and/or fiber. The electroconductive resin composition may preferably be used for a fuel cell separator.

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